

# Messrs. Digi-Key

# **Product Specification** (KYOCERA CORPORATION CERAMIC RESONATOR SPECIFICATION)

# **RoHS compliant**

CONFIRMED

(Please sign here and send one copy back to us.)

| Specification<br>No. |          | <b>EQM08-5KC-G5PQ805-00</b><br>(QK-SB210-PE0625-A) |                  |  |  |  |
|----------------------|----------|--|------------------|--|--|--|
| Type Name PRG        |          |  | V20.00CR1510Y00L |  |  |  |
| 00                   | Apr, 16, | 2014   |                  |  |  |  |
|                      |          |  |                  |  |  |  |
| Approved by          |          | by   | T.Sugihara       |  |  |  |
| Checked by           |          | K.Katsuyama  |                  |  |  |  |
| Checked by           |          | T.Matsuoka   |                  |  |  |  |
| Issued by            |          | N.Arima  |                  |  |  |  |

# 1. Scope

This document shall cover the specifications of the ceramic resonator applied for clock oscillator of a microcomputer.

# 2. Kyocera's Type Name PRQV20.00CR1510Y00L

# 3. Customer's Type Name

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# 4. Electrical Characteristics

# Table 1 Product Specification Items Specifications Oscillating Frequency 20.00 MHz Initial Frequency Tolerance ± 0.15 % Resonant Impedance 100 Q max

| Resonant Impedance                              | 100 Ω max.                            |
|---|---------------------------------------|
| Temperature Characteristics                     | ± 0.10 %                              |
| on Oscillating Frequency<br>(Temperature Drift) | (-40 to +125 °C)                      |
| Standard Test IC                                | MC74HCU04 (Freescale)                 |
| Withstanding Voltage                            | 100V D.C. 10 seconds max              |
| Max. Input Signal Voltage                       | 15 Vp-р                               |
| Insulation Resistance                           | 100 M $\Omega$ min (at 10V D.C.)      |
| Operating Temperature<br>Range                  | -40 to +125 °C                        |
| Storage Temperature<br>Range                    | -40 to +125 °C                        |
| Aging for 10 Years<br>on Oscillating Frequency  | ±0.05 %<br>at 25°C from initial value |

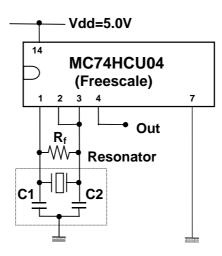
# 4-1. Measurement Condition

The reference temperature shall be  $25 \pm 2$  °C. The measurement shall be performed in the temperature range from 15 °C to 35 °C unless otherwise the result is doubtful.

# 4-2. Measurement Circuit

Oscillating frequency shall be measured using the Kyocera standard test circuit shown in Fig 1.

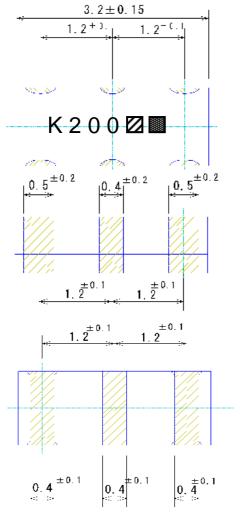




 $R_f=1M\Omega$ C1=C2= 10 pF (Reference)

# Fig 1 Standard Measuring Circuit

# 5. Appearance & Dimensions



**Oscillating Frequency** 

e.g:200 show the oscillating frequency of 20.00 MHz.

# Date Code

| 2013 | Jan. | ~ | Dec. | A~M (except "I")   |
|------|------|---|------|--------------------|
| 2014 | Jan. | ~ | Dec. | N~Z (except "O")   |
| 2015 | Jan. | ~ | Dec. | a~m (except " i ") |
| 2016 | Jan. | ~ | Dec. | n~z (except "o")   |

Note: The alphabet should be repeated after Jan.2017.

# Day Code

1. 3±0. 15 ∵

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1.00max.

| Day  | 1  | 2  | 3  | 4  | 5  | 6  | 7  | 8  | 9  | 10 |    |
|------|----|----|----|----|----|----|----|----|----|----|----|
| Code | А  | В  | С  | D  | Е  | F  | G  | Н  | J  | Κ  |    |
| Day  | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 |    |
| Code | L  | М  | Ν  | Ρ  | Q  | R  | S  | Т  | U  | V  |    |
| Day  | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 |
| Code | W  | Х  | Υ  | Ζ  | а  | b  | С  | d  | е  | f  | g  |

#### Appearance

There should be no mechanical damages, which are markedly out of this specification.

Terminal: Ni/Sn plating

Fig 2 Dimensions



Unit: mm

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# 7. Environmental Characteristics

**Table 2 Enviromental Characteristics** 

A. Series (MHz Band SMD Ceramic Resonator)

- B. Oscillating Frequency (eg. 20.00 MHz)
- C. Type
- D. Packing (Tape & Reel 3000 pcs/Reel)
- E. Initial Frequency Tolerance F. Bult-in Capacitor(10pF: Standard)
- G. Operating Temp. Range
- H. Unique Code

| 7-1. HumidityaSS7-2. HighATemperaturete7-3. LowATemperaturete7-4. Temperature1 | After leaving in a chamber at 80 to 85 % R.H. and $85 \pm 2^{\circ}$ C for 1000 +12/-0 hours<br>and then left at room temperature for 1 hour the resonator shall meet the<br>specifications shown in Table 3.<br>After leaving in a chamber at $125 \pm 2^{\circ}$ C for 1000 +12/-0 hours and then left at room<br>emperature for 1 hour, the resonator shall meet the specifications shown in Table 3.<br>After leaving in a chamber at $-40 \pm 3^{\circ}$ C for 1000 +12/-0 hours and then left at room<br>emperature for 1 hour, the resonator shall meet the specifications shown in Table 3.<br>After leaving in a chamber at $-40 \pm 3^{\circ}$ C for 1000 +12/-0 hours and then left at room<br>emperature for 1 hour, the resonator shall meet the specifications shown in Table 3.<br>After leaving in a chamber at $-40 \pm 3^{\circ}$ C for 30 minutes, then the resonator is left at |
|--|---|
| Temperaturete7-3. LowATemperaturete7-4. Temperature1                           | emperature for 1 hour, the resonator shall meet the specifications shown in Table 3. After leaving in a chamber at $-40 \pm 3^{\circ}$ C for 1000 +12/-0 hours and then left at room emperature for 1 hour, the resonator shall meet the specifications shown in Table 3.   |
| TemperatureteA7-4. Temperature1  | emperature for 1 hour, the resonator shall meet the specifications shown in Table 3.  |
| 7-4. Temperature 1   | Ster leaving in a chamber at $-40 + 3$ °C for 30 minutes, then the resonator is left at 1   |
|  | $125 \pm 2^{\circ}$ C for 30 minutes. This procedure is one cycle. After leaving in 1000 cycles, and then left at room temperature for 1 hour, the resonator shall meet the specifications shown in Table 3.  |
| 7-5. Mechanical A<br>Shock (e  | After applying the acceleration at 29430m/sec <sup>2</sup> {3000G} in each of X, Y and Z axis each 3 time), the resonator shall meet the specifications in Table 3.   |
| 7-6. Vibration fr  | After applying the vibration at amplitude 1.5 mm and 10 to 55 Hz of vibration requency in each of 3 mutually perpendicular directions for 1 hour, the resonator shall meet the specifications shown in Table 3.   |
| 7-7. Solderability for   | At first, being soaked in the Methanol (JIS K1501) solution containing Rosin (JIS K5902) for 5 seconds and next being soaked in a bath of Pb/Sn solder at $235 \pm 5^{\circ}$ C or $4 \pm 0.5$ seconds, then more than 95% the surface of the electrode terminal shall be soldered.   |
| 7-8. Reflow te<br>Soldering a  | At first, leaving at 150 to 180°C of pre-heat for 90 to 120 seconds, next left at peak<br>emperature 260+0/-5°C, over 230°C for 30 to 40seconds (2times). Finally leaving<br>at room temperature for 1 hour. The resonator shall meet the specifications shown<br>n Table 3.  |
| 7-9. Cleaning 2  | <ul> <li>I)Ultrasonic cleaning: The resonator is washed with iso-propyl alcohol at room temperature with condition of 20KW/m3 and 28kHz for 60sec.</li> <li>No significant damage on the resonator shall occur and marking shall be safely readable.</li> <li>2)Soaking cleaning: The resonator is soaked in iso-propyl alcohol at room emperature for 90sec. No significant damage on the resonator shall occur and marking shall be safely readable.</li> </ul>   |
| A<br>b<br>a<br>7-10. Bend<br>strength  | After soldered on the board specified as below, then the load which cause 3 mm point to the board is applied, the resonator shall meet the specifications in Table 3 and cause no defect in the appearance.<br>12 $12$ $12$ $12$ $12$ $12$ $12$ $12$  |



| Items   | Specifications |
|---|----------------|
| Oscillating Frequency<br>(from initial value) | ±0.2 % max     |
| Resonant Impedance                            | 150 Ω max.     |

# 8. Recommendable land pattern

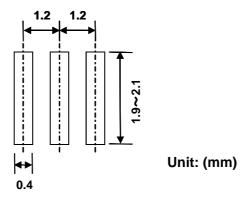


Fig.4 Recommended Land pattern

# 9. Recommendable reflow profile

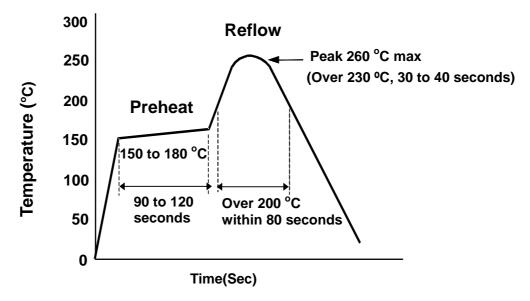
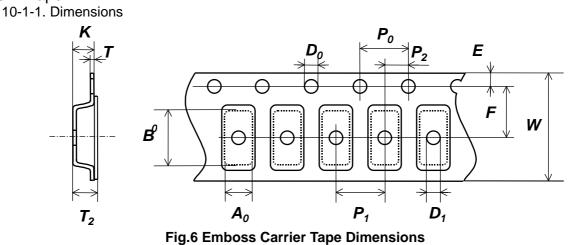


Fig.5 Recommended IR Reflow profile



# **10. Taping Specifications**





## **Table 4 Emboss Carrier Tape Dimensions**

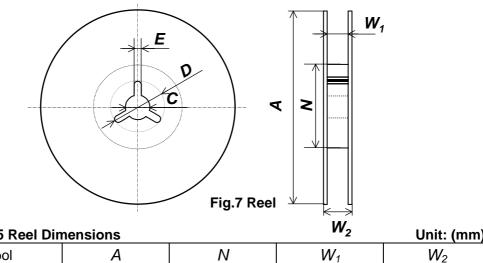
| Symbol     | $A_0$    | $B_0$          | W         | F                     | Е        | <i>P</i> <sub>1</sub> | $P_2$                 |
|------------|----------|----------------|-----------|-----------------------|----------|-----------------------|-----------------------|
| Dimensions | 1.55±0.2 | 3.45±0.2       | 8.00±0.3  | 3.50±0.05             | 1.75±0.1 | 4.00±0.1              | 2.00±0.05             |
| Symbol     | $P_0$    | D <sub>0</sub> | Т         | <i>T</i> <sub>2</sub> | K        | Ľ                     | <b>D</b> <sub>1</sub> |
| Dimensions | 4.00±0.1 | 1.50+0.1/-0    | 0.25±0.05 | 1.40max.              | 1.10±0.2 | 1.0+0                 | ).1/-0                |

# 10-2. Taping

10-2-1. Taping Quantity

One reel of the tape shall pack 3000 pcs resonators maximum. No resonator shall be missing and contained continuously in pocket.

# 10-2-2. Reel Dimensions

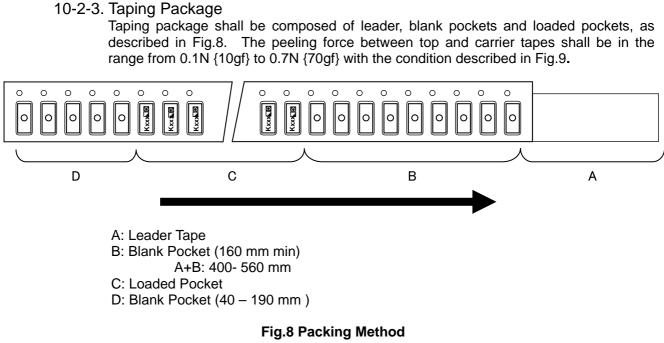


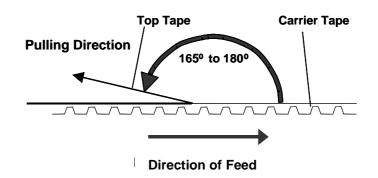
| Table 5 Reel Dir | nensions |          | W <sub>2</sub> | Unit: (mm)            |
|------------------|----------|----------|----------------|-----------------------|
| Symbol           | A        | N        | $W_1$          | <i>W</i> <sub>2</sub> |
| Dimensions       | 180+0/-9 | 50 min   | 9.0±0.3        | 12.4 Max              |
| Symbol           | С        | D        | E              |                       |
| Dimensions       | 13.0±0.5 | 21.0±0.8 | 2.0±0.5        |                       |

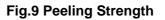


Unit: (mm)

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## 10-2-5. Reel Label

A reel label shall consist as below.

- A) Customer P/N
- B) Lot No.
- C) Quantity
- D) Shipping date
- E) Vender name

## 10-2-6. Exterior Package Label

The resonators shall be packed properly to avoid defect in transportation and the marking of the exterior package shall contain information described as below.

- A) Name of customer
- B) P/O No.
- C) Customer P/N
- D) Lot No.
- E) Quantity
- F) Shipping date
- G) Vender name



# 11. Agreement on this Specification

Should any part of the content of this specification become questionable, it shall be settled by mutual deliberations.

# 12. Remarks on Usage

- 12-1.In case that such stronger shock and vibration, higher temperature that shall be specified were to be applied to the resonator, it would occasionally become out of order. So please pay plenty of attention to its usage.
- 12-2. This part is available for reflow soldering only. The ceramic resonator may be damaged in case of reflow soldering at temperatures higher than 260 oC.
- 12-3.Ensure that your circuit design is fully characterized for your IC. For recommendations of component values, please contact IC manufacturer or our local sales office before mass production. Please note there may be some oscillation problems in case of not suitable circuit design.
- 12-4. Storage condition

Please use the ceramic resonator within one year from the shipping date under room storage condition less than 30 oC and 60%RH with the shipped package.

12-5.Fail-safe

Be sure to provide an appropriate fail-safe function on your system or subsystem to prevent a second damage that may be caused by an abnormality or failure related to our product.

12-6Limitation of use

Make sure to contact us in advance before considering using this product for the following applications which would require particularly high reliability due to possibility of direct harm to lives and/or properties.

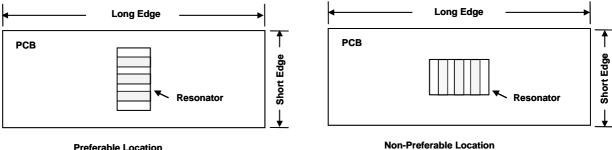
- (1) Use in aerospace or space
- (2) Use in seabed or underground
- (3) Use in control of power station firepower, waterpower, nuclearpower, etc
- (4) Use in medical treatments including instruments related to lifesaver
- (5) Use in transportation trains, ships, etc.
- (6) Use in traffic controls
- (7) Use in protection/prevention against disasters or crimes
- (8) Others Use in the equivalent applications mentioned above
- 12-7. This product is designed and manufactured with intention to be used in general electronic equipments for standard applications but with no intention to be used in the following environments which may affect performance of this product. Therefore, make sure to have enough confirmation on performance and reliability of this product in the following environments in advance before use.
  - (1) Use in liquids such as water, oil, medical liquid, organic solvent, etc
  - (2) Use in direct sunshine, rain, wind, or dust/dirt
  - (3) Use in sea wind or place with corrosive gas such as Cl2, H2S, NH3, SO2, NO2, etc
  - (4) Use in environment with strong static electricity or electromagnetic wave
  - (5) Use in located nearly to heat generating part or flammable materials such as vinyl wires
  - (6) Use in sealed or coated by materials such as resin, etc
  - (7) Use in condensation



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# 13. Placement of the Resonator

The resonator should be placed on PCB as described follow to avoid any mechanical stresses applied to the part.



**Non-Preferable Location** 

#### **Fig.10 Mounting Direction**

# 14. Environment Hazardous Substance (RoHS Compliant Certificate)

The environment hazardous substance in Table 6 is not being used to the raw materials and also manufacturing process of this product and packaging (except impurities). Lead (Pb) used in the resonator products is exempted from RoHS requirements in the ANNEX.

| Enviromental Load Substance  |   |  |  |  |
|--|---|--|--|--|
| Substances   | Content   |  |  |  |
| Substances Inhibited by the Law in Japan                                   | Products  | Reel and Packages  |  |  |
| Cadmium and cadmium compounds  | None  | None   |  |  |
| PBB (polybrominated biphenyl) s and PBDE (polybrominated biphenyl ether) s | None  | None   |  |  |
| Chlorinated paraffins (Chlorines Flame retarder/Plasticizer)               | None  | None   |  |  |
| PCB (polychlorinated biphenyl) s   | None  | None   |  |  |
| Poly chloridation naphthalenes   | None  | None   |  |  |
| Organo tin compounds<br>(Tributyl tins/ Triphenyl tins)                    | None  | None   |  |  |
| Asbestos   | None  | None   |  |  |
| Azo compounds  | None  | None   |  |  |
| Others   |   |  |  |  |
| Lead (Pb)  | Yes   | None   |  |  |
|  | SubstancesSubstances Inhibited by the Law in JapanCadmium and cadmium compoundsPBB (polybrominated biphenyl) s and PBDE<br>(polybrominated biphenyl ether) sChlorinated paraffins (Chlorines Flame<br>retarder/Plasticizer)PCB (polychlorinated biphenyl) sPCB (polychlorinated biphenyl) sPoly chloridation naphthalenesOrgano tin compounds<br>(Tributyl tins/ Triphenyl tins)AsbestosAzo compoundsOthers | SubstancesSubstances Inhibited by the Law in JapanProductsCadmium and cadmium compoundsNonePBB (polybrominated biphenyl) s and PBDE<br>(polybrominated biphenyl ether) sNoneChlorinated paraffins (Chlorines Flame<br>retarder/Plasticizer)NonePCB (polychlorinated biphenyl) sNonePOly chloridation naphthalenesNoneOrgano tin compounds<br>(Tributyl tins/ Triphenyl tins)NoneAsbestosNoneOthersOthers |  |  |

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